

NCE 60V Complementary MOSFET

Description

The NCE603S uses advanced trench technology and design to provide excellent $R_{\text{DS}(\text{ON})}$ with low gate charge. It can be used in a wide variety of applications.

General Features

N channel

V_{DS} =60V,I_D =5A

 $R_{DS(ON)}$ <28m Ω @ V_{GS} =10V

 $R_{DS(ON)}$ <38m Ω @ V_{GS} =4.5V

p channel

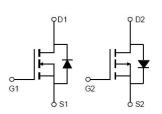
● V_{DS} =-60V,I_D =-4A

 $R_{DS(ON)}$ <80m Ω @ V_{GS} =-10V

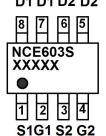
- High density cell design for ultra low Rdson
- Fully characterized avalanche voltage and current
- Good stability and uniformity with high E_{AS}
- Excellent package for good heat dissipation
- Special process technology for high ESD capability

Application

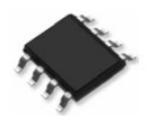
- H-bridge
- Inverters



Schematic diagram D1 D1 D2 D2



Marking and pin assignment



SOP-8 top view

Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
NCE603S	NCE603S	SOP-8	Ø330mm	12mm	4000 units

Absolute Maximum Ratings (T_A=25℃unless otherwise noted)

Parame	Symbol	N-Channel	P-Channel	Unit		
Drain-Source Voltage		V _{DS}	60	-60	V	
Gate-Source Voltage	V _{GS}	±20	±20	V		
Oti	T _C =25℃	1	5	-4	Δ	
Continuous Drain Current	Tc=100°C	I _D	3.5	-2.8	Α	
Pulsed Drain Current (Note 1)		Ірм	30	-30	Α	
Maximum Power Dissipation T _C =25℃		P _D	2	2	W	
Operating Junction and Storage T	T _J ,T _{STG}	-55 To 150	-55 To 150	$^{\circ}\!\mathbb{C}$		

Thermal Characteristic

N-channel	Thermal Resistance,Junction-to- Ambient (Note 2)	Reja	62.5	°C/W
P-channel	Thermal Resistance,Junction-to- Ambient (Note 2)	Reja	62.5	°C/W
N-channel	Thermal Resistance,Junction-to- Lead (Note 2)	Rejl	30	°C/W
P-channel	Thermal Resistance,Junction-to- Lead (Note 2)	R _{θJL}	30	°C/W



N-Channel Electrical Characteristics (T_A=25 ℃ unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics			•	•		,
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =250µA	60	-	-	V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =60V,V _{GS} =0V	-	-	1	μA
Gate-Body Leakage Current	I _{GSS}	V _{GS} =±20V,V _{DS} =0V	-	-	±100	nA
On Characteristics (Note 3)				•		
Gate Threshold Voltage	V _{GS(th)}	$V_{DS}=V_{GS},I_{D}=250\mu A$	1.0	1.6	2.5	V
Dunin Course On State Begintanes	R _{DS(ON)}	V _{GS} =10V, I _D =5A	-	24	28	mΩ
Drain-Source On-State Resistance	R _{DS(ON)}	V _{GS} =4.5V, I _D =5A		32	38	mΩ
Forward Transconductance	G FS	V _{DS} =5V,I _D =5A	11	-	-	S
Dynamic Characteristics (Note4)				•		
Input Capacitance	C _{lss}	\/ -20\/\/ -0\/	-	979	-	PF
Output Capacitance	Coss	V_{DS} =30V, V_{GS} =0V, F=1.0MHz	-	120	-	PF
Reverse Transfer Capacitance	C _{rss}	F=1.UIVIHZ	-	100	-	PF
Switching Characteristics (Note 4)				•		
Turn-on Delay Time	t _{d(on)}		-	4.2	-	nS
Turn-on Rise Time	tr	V _{DD} =30V ,R _L =2.5Ω	-	3.4	-	nS
Turn-Off Delay Time	t _{d(off)}	V_{GS} =10 V , R_{G} =3 Ω	-	16	-	nS
Turn-Off Fall Time	t _f		-	2	-	nS
Total Gate Charge	Qg	\/ 00\/ L FA	-	22		nC
Gate-Source Charge	Q _{gs}	$V_{DS}=30V,I_{D}=5A,$	-	3.3		nC
Gate-Drain Charge	Q_{gd}	V _{GS} =10V	-	5.2		nC
Drain-Source Diode Characteristics			•	•		
Diode Forward Voltage (Note 3)	V _{SD}	V _{GS} =0V,I _S =5A	-		1.2	V
Diode Forward Current (Note 2)	Is		-	-	5	Α
Reverse Recovery Time	t _{rr}	TJ = 25°C, IF =5A	-	27	-	nS
Reverse Recovery Charge	Qrr	di/dt = 100A/µs ^(Note3) -		30	-	nC
Forward Turn-On Time	t _{on}	Intrinsic turn-on time is negligible (turn-on is dominated by LS+LD				

Notes:

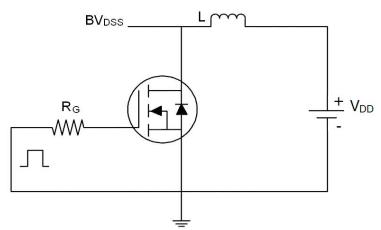
- 1. Repetitive Rating: Pulse width limited by maximum junction temperature.
- 2. The value of R_{θJA} is measured with the device mounted on 1in 2 FR-4 board with 2oz. Copper, in a still air environment with TA =25°C.

 The value in any a given application depends on the user's specific board design. The R_{θJA} i is the sum of the thermal impedence from junction to lead R_{θJL} and lead to ambient.
- 3. Pulse Test: Pulse Width \leq 300 μ s, Duty Cycle \leq 2%.
- 4. Guaranteed by design, not subject to production

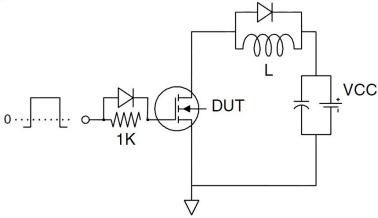


Test Circuit

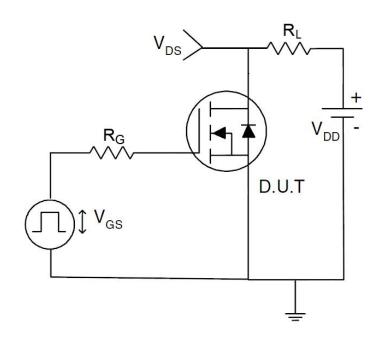
1) Eas test Circuit



2) Gate charge test Circuit



3) Switch Time Test Circuit







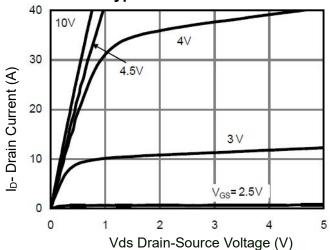


Figure 1 Output Characteristics

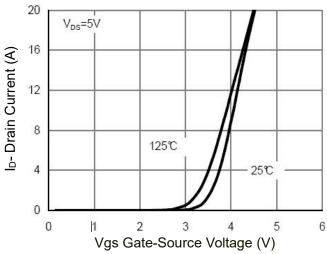


Figure 2 Transfer Characteristics

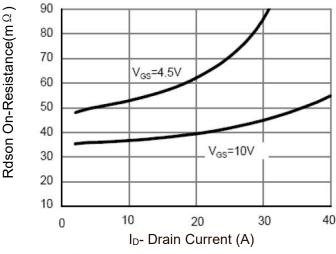


Figure 3 Rdson- Drain Current

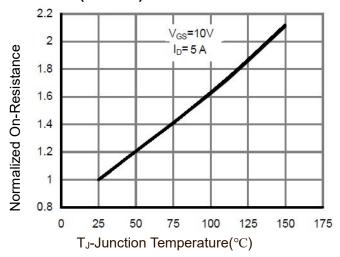


Figure 4 Rdson-Junction Temperature

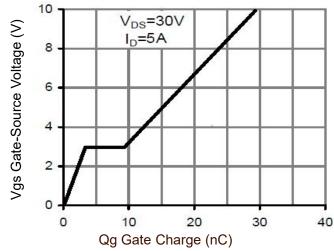


Figure 5 Gate Charge

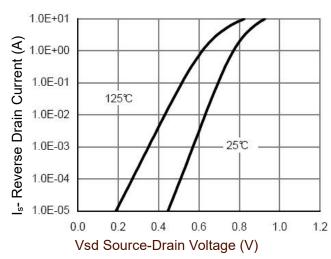


Figure 6 Source- Drain Diode Forward



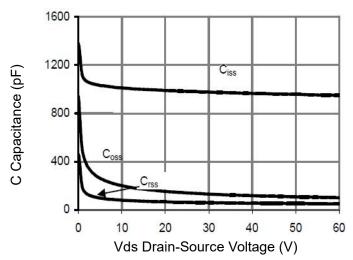


Figure 7 Capacitance vs Vds

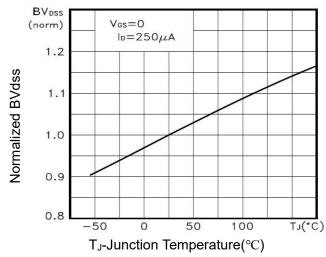


Figure 9 BV_{DSS} vs Junction Temperature

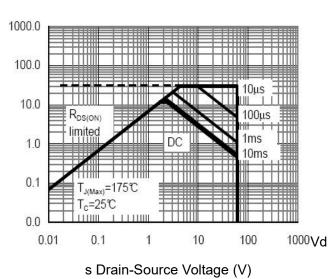


Figure 8 Safe Operation Area

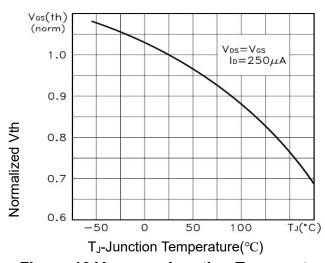


Figure 10 V_{GS(th)} vs Junction Temperature

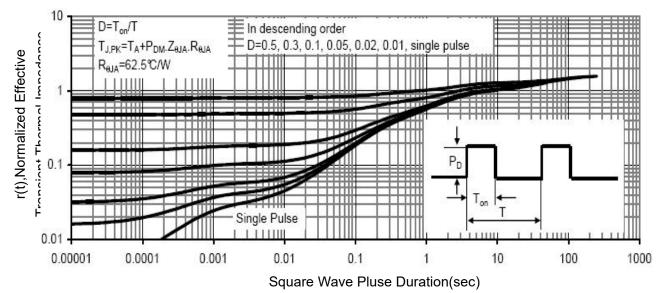


Figure 11 Normalized Maximum Transient Thermal Impedance



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P-Channel Electrical Characteristics (T_{C} =25 $^{\circ}$ C unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics						
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =-250µA	-60	-	-	V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =-60V,V _{GS} =0V	-	-	-1	μA
Gate-Body Leakage Current	I _{GSS}	V _{GS} =±20V,V _{DS} =0V	-	-	±100	nA
On Characteristics (Note 3)				,		
Gate Threshold Voltage	V _{GS(th)}	V _{DS} =V _{GS} ,I _D =-250μA	-1.5	-2.6	-3.0	V
Drain-Source On-State Resistance	R _{DS(ON)}	V _{GS} =-10V, I _D =-4A	-	64	80	mΩ
Forward Transconductance	g FS	V _{DS} =-5V,I _D =-4A	11	-	-	S
Dynamic Characteristics (Note4)						
Input Capacitance	Clss	N 001/N 01/	-	960	-	PF
Output Capacitance	Coss	V _{DS} =-30V,V _{GS} =0V,	-	86	-	PF
Reverse Transfer Capacitance	C _{rss}	F=1.0MHz	-	38	-	PF
Switching Characteristics (Note 4)				•		
Turn-on Delay Time	t _{d(on)}		-	9	-	nS
Turn-on Rise Time	t _r	V_{DD} =-30V , R_L =2.5 Ω	-	10	-	nS
Turn-Off Delay Time	t _{d(off)}	V _{GS} =-10V,R _G =3Ω	-	25	-	nS
Turn-Off Fall Time	t _f		-	11	-	nS
Total Gate Charge	Qg	\/ 00\/ L	-	15.8		nC
Gate-Source Charge	Q _{gs}	V_{DS} =-30V, I_{D} =-4A, V_{GS} =10V	-	3		nC
Gate-Drain Charge	Q _{gd}	V _{GS} =10V	-	3.5		nC
Drain-Source Diode Characteristics						
Diode Forward Voltage (Note 3)	V _{SD}	V _{GS} =0V,I _S =-4A	-		-1.2	V
Diode Forward Current (Note 2)	Is		-	-	-4	Α
Reverse Recovery Time	t _{rr}	TJ = 25°C, IF =-4A	-	27.5	-	nS
Reverse Recovery Charge	Qrr	di/dt = 100A/µs ^(Note3) - 30 -		-	nC	
Forward Turn-On Time	t _{on}	Intrinsic turn-on time is negligible (turn-on is dominated by LS+LD				



P-Channel Typical Electrical and Thermal Characteristics (Curves)

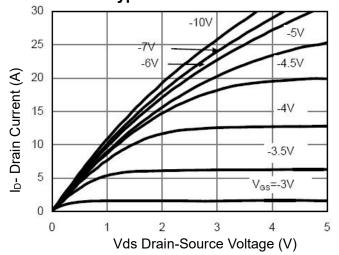


Figure 1 Output Characteristics

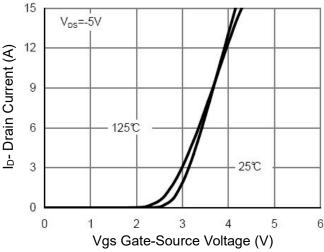
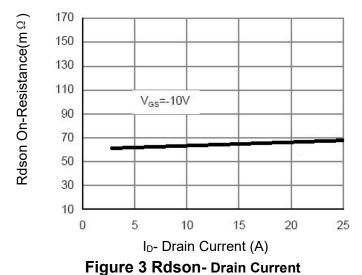


Figure 2 Transfer Characteristics



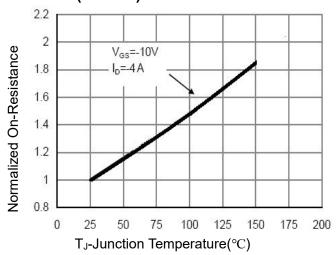


Figure 4 Rdson-Junction Temperature

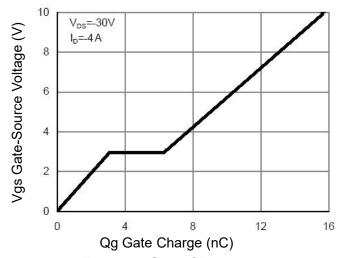


Figure 5 Gate Charge

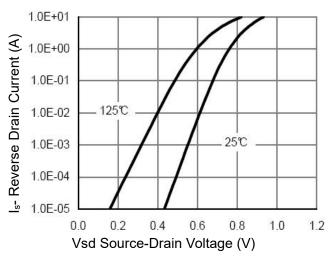


Figure 6 Source- Drain Diode Forward



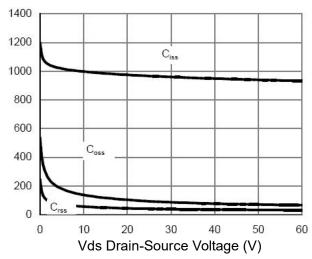


Figure 7 Capacitance vs Vds

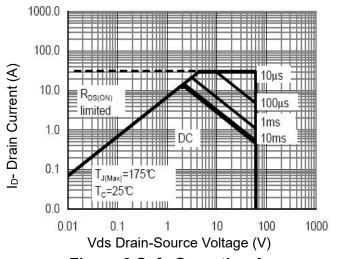


Figure 8 Safe Operation Area

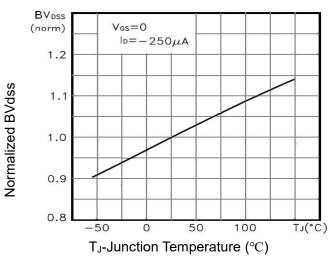


Figure 9 BV_{DSS} vs Junction Temperature

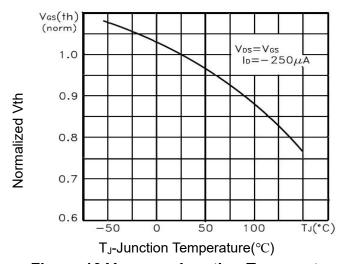


Figure 10 V_{GS(th)} vs Junction Temperature

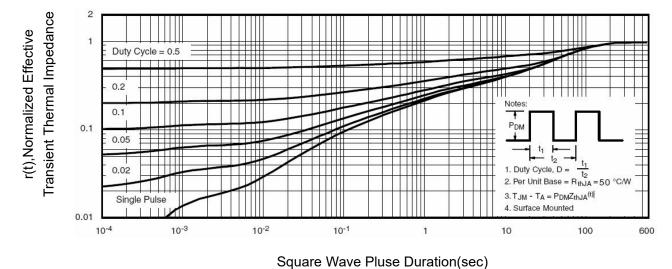
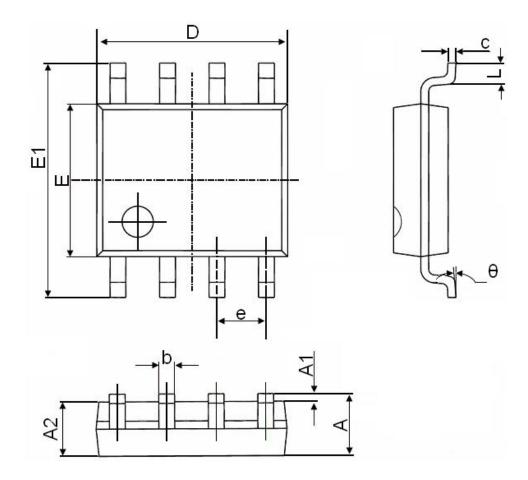


Figure 11 Normalized Maximum Transient Thermal Impedance



SOP-8 Package Information



Symbol	Dimensions	n Millimeters	Dimensions In Inches		
	Min.	Max.	Min.	Max.	
А	1.350	1.750	0.053	0.069	
A1	0.100	0.250	0.004	0.010	
A2	1.350	1.550	0.053	0.061	
b	0.330	0.510	0.013	0.020	
С	0.170	0.250	0.006	0.010	
D	4.700	5.100	0.185	0.200	
E	3.800	4.000	0.150	0.157	
E1	5.800	6.200	0.228	0.244	
е	1.270	(BSC)	0.050(BSC)		
L	0.400	1.270	0.016	0.050	
θ	0°	8°	0°	8°	

Attention:



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NCE603S

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